ALTERNATION HISTORY RECORDS 变更记录

Date 日期	Version 版本	Mark 标记	Page 页码	Description 描述	Drafter 制定者	Approver 审批者
2021-5-25	A	/	P8	In release	Doris	/

1.Part Numbering System):

RCR	03	J	A	10K
Series Name Chip Resistor: RCR: General purpose chip resistors (Pb≤100 ppm)	Type Inch (mm) 02-0402(1005) 03-0603(1608) 05-0805(2012) 06-1206(3216) 10-1210(3225)	Tolerance B= ± 0.1% D= ± 0.5% F= ± 1% J= ± 5 % P：Jumper	Package A=4Kpcs/7"Reel B=5Kpcs/7"Reel C=10Kpcs/7"Reel M=15Kpcs/7"Reel D=10Kpcs/10"Reel E=20Kpcs/10"Reel	Resistance 1R2=1.2Ω 10K=10KΩ 10K5=10.5KΩ 100K=100KΩ 1M2=1.2MΩ

2.FEATURE

- High reliability and stability
- Reduced size of final equipment
- Lower assembly costs
- Higher component and equipment reliability
- RoHS exemption free and Lead free products

3. APPLICATION

- Consumer electrical equipment
- Automotive application
- EDP, Computer application
- Telecom application

4.DESCRIPTION

The **LEAD FREE** resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a **LEAD FREE** resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat. **For all series, Overcoat is water blue color.** Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (**LEAD FREE**) alloy.

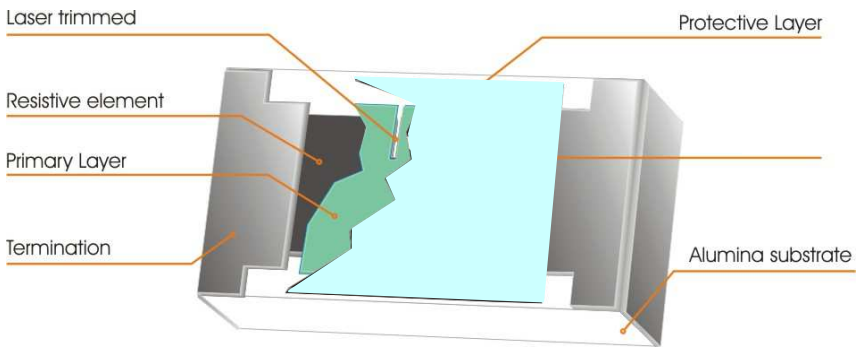


Fig 1. Construction of a Chip-R

*Contents in this sheet are subject to change without prior notice.

5.QUICK REFERENCE DATA

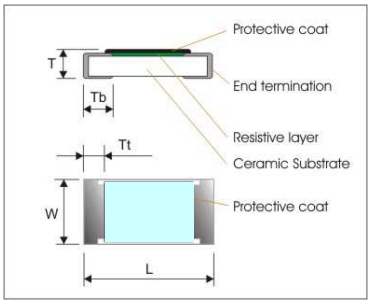
Item	General Specification									
Series No.	RCR10		RCR06		RCR05		RCR03		RCR02	
Size code	1210(3225)		1206(3216)		0805(2012)		0603(1608)		0402(1005)	
Resistance Range	1Ω ~10MΩ (±5% tolerance), 1Ω ~ 10MΩ (±1% tolerance), Jumper									
Resistance Tolerance	±1% E24/E96	±5% E24	±1% E24/E96	±5% E24	±1% E96/E24	±5% E24	±1% E96/E24	±5% E24	±1% E96/E24	±5% E24
TCR (ppm/°C) R≥1MΩ 1MΩ＞R＞10Ω R≤10Ω	 ≤ ± 200 ≤ ± 100 -300/+500	 ≤ ± 200 ≤ ± 200 -300/+500	 ≤ ± 200 ≤ ± 100 -300/+500	 ≤ ± 200 ≤ ± 200 -300/+500	 ≤ ± 200 ≤ ± 100 -300/+500	 ≤ ± 200 ≤ ± 200 -300/+500	 ≤ ± 200 ≤ ± 100 -300/+500	 ≤ ± 200 ≤ ± 200 -300/+500	 ≤ ± 300 ≤ ± 100 -300/+500	 ≤ ± 300 ≤ ± 200 -300/+500
Max. dissipation @ T_{amb}=70°C	1/3 W		1/4 W		1/8 W		1/10 W		1/16 W	
Max. Operation Voltage (DC or RMS)	200V		200V		150V		50V		50V	
Max. Overload Voltage (DC or RMS)	400V		400V		300V		100V		100V	
Climatic category (IEC 60068)	55/155/56									

Note :

1. This is the maximum voltage that may be continuously supplied to the resistor element, see “IEC publication 60115-8”
2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by
3. $RCWV = \sqrt{Rated\,Power \times Resistance\,Value}$ or Max. RCWV listed above, whichever is lower.
4. The resistance of Jumper is defined as max. 0.05Ω.

6.DIMENSIONS (unit : mm)

	RCR10	RCR06	RCR05	RCR03	RCR02
L	3.10 ± 0.10	3.10 ± 0.10	2.00 ± 0.10	1.60 ± 0.10	1.00 ± 0.05
W	2.60 ± 0.10	1.60 ± 0.10	1.25 ± 0.10	0.80 ± 0.10	0.50 ± 0.05
T	0.55 ± 0.10	0.60 ± 0.15	0.50 ± 0.15	0.45 ± 0.15	0.35 ± 0.05
Tb	0.50 ± 0.20	0.45 ± 0.20	0.40 ± 0.20	0.30 ± 0.15	0.25 ± 0.10
Tt	0.50 ± 0.20	0.50 ± 0.20	0.40 ± 0.20	0.30 ± 0.10	0.20 ± 0.10



7. MARKING

All series are defined as no marking !

8.FUNCTIONAL DESCRIPTION

8.1Product characterization

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of ±5%, and E96 series for resistors with a tolerance of ±1%. The values of the E24/E96 series are in accordance with "IEC publication 60063"

8.2 De-rating

The power that the resistor can dissipate depends on the operating temperature; see Fig.2.1

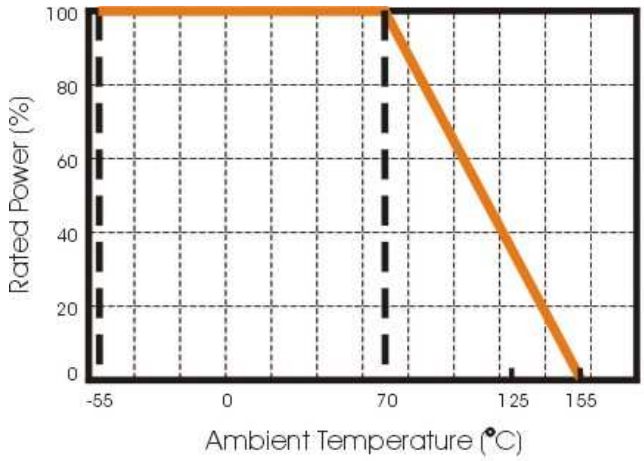


Figure 2.1 Maximum dissipation in percentage of rated power as a function of the ambient temperature for RCR10, RCR06 RCR05, RCR03, RCR02

8.3 MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

8.4 SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

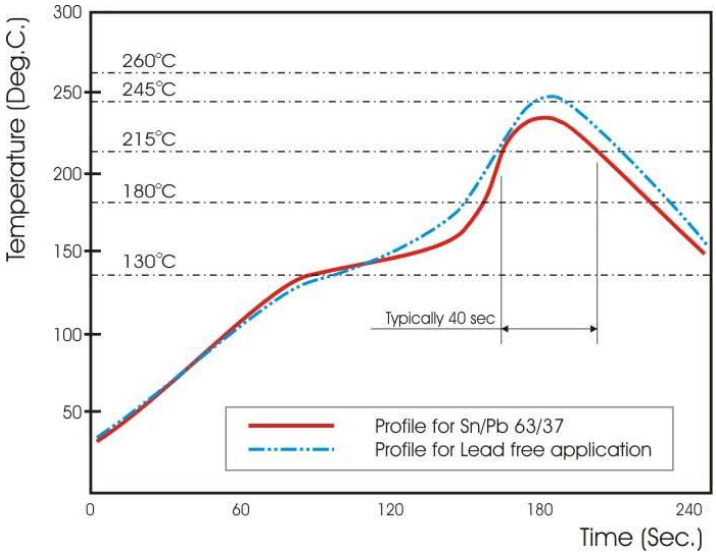


Fig 3. Infrared soldering profile for Chip Resistors

LEAD content: below 100ppm with reference to IEC62321, determination of LEAD by ICP-AES

RCR10, RCR06,RCR05,RCR03:

1. Reeled tape packaging : 8mm width paper taping 5000pcs per 7” reel, 10kpcs per 10” reel, 20kpcs per 13” reel.
2. Bulk packaging : 5000pcs per poly-bag

RCR02:

1. Reeled tape packaging : 8mm width paper taping 10,000pcs per reel,
2. Bulk packaging : 10,000pcs per poly-bag

8.5 TEST AND REQUIREMENTS(JIS C 5201-1 : 1998)

Essentially all tests are carried out according to the schedule of **IEC publication 115-8,** category **LCT/UCT**/56(rated temperature range : **L**ower **C**ategory **T**emperature, **U**pper **C**ategory **T**emperature; damp heat, long term, 56 days). **The testing also meets the requirements specified by EIA, EIAJ and JIS.**

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied :

Temperature: 15°C to 35°C.

Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

All soldering tests are performed with midly activated flux.

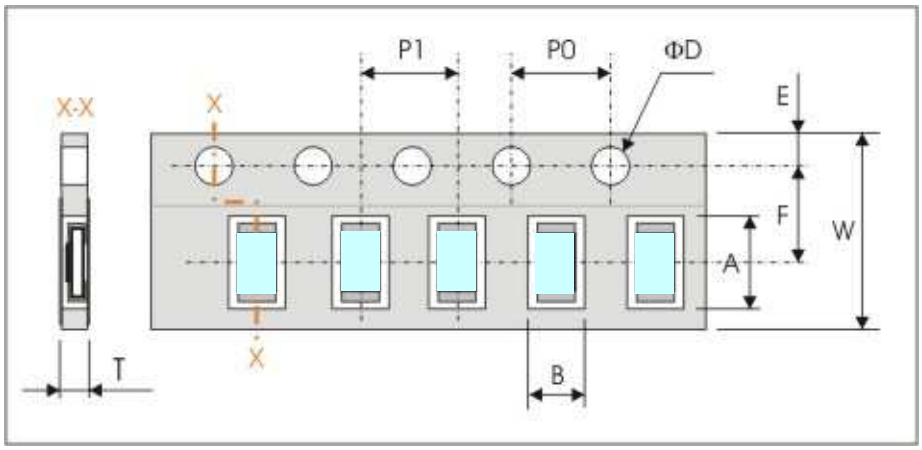
TEST	PROCEDURE / TEST METHOD	REQUIREMENT	
		Resistor	0Ω
DC resistance **Clause 4.5**	DC resistance values measured at the test voltages specified below : <10Ω@0.1V, <100Ω@0.3V, <1KΩ@1.0V, <10KΩ@3V, <100KΩ@10V, <1MΩ@25V, <10MΩ@30V	Within the specified tolerance	<50mΩ
Temperature Coefficient of Resistance(T.C.R) **Clause 4.8**	Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6$ (ppm/°C) t_1 : 20℃+5℃-1℃ R_1 : Resistance at reference temperature R_2 : Resistance at test temperature	Refer to "QUICK REFERENCE DATA"	N/a
Short time overload (S.T.O.L) **Clause 4.13**	Permanent resistance change after a 5second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	1% tol.: ΔR/R max. ±(1%+0.10Ω) 5% tol.: ΔR/R max. ±(2%+0.10Ω)	<50mΩ
Resistance to soldering heat(R.S.H) **Clause 4.18**	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260℃±5°C	1% tol.: ΔR/R max. ±(0.5%+0.10Ω) 5% tol.: ΔR/R max. ±(1%+0.10Ω)	<50mΩ
Solderability **Clause 4.17**	Un-mounted chips completely immersed for 2±0.5 second in a SAC solder bath at 235℃±5℃	95% coverage min., good tinning and no visible damage	
Temperature cycling **Clause 4.19**	30 minutes at -55°C±3°C, 2~3 minutes at 20℃+5℃-1℃, 30 minutes at +155°C±3°C, 2~3 minutes at 20℃+5℃-1℃, total 5 continuous cycles	1% tol.: ΔR/R max. ±(0.5%+0.10Ω) 5% tol.: ΔR/R max. ±(1%+0.10Ω)	<50mΩ
Damp Heat (Load life in humidity) **Clause 4.24**	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	1% tol.: ΔR/R max. ±(1%+0.10Ω) 5% tol.: ΔR/R max. ±(2%+0.10Ω)	<50mΩ
Load Life(Endurance) **Clause 4.25**	1000 +48/-0 hours; loaded with RCWV or V_{max} in chamber controller 70±2°C, 1.5 hours on and 0.5 hours off	1% tol.: ΔR/R max. ±(1%+0.10Ω) 5% tol.: ΔR/R max. ±(2%+0.10Ω)	<50mΩ
Bending strength **Clause 4.33**	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending once 3mm for 10sec, 5mm for WR04	1% tol.: ΔR/R max. ±(0.5%+0.10Ω) 5 tol.: ΔR/R max. ±(1%+0.10Ω)	<50mΩ
Adhesion **Clause 4.32**	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations	

8.6TEST CONDITION FOR JUMPER (0Ω)

Item	RCR10	RCR06	RCR05	RCR03	RCR02
Power Rating At 70°C	1/3W	1/4W	1/8W	1/10W	1/16W
Resistance	MAX.50mΩ				
Rated Current	2.5A	2A	1.5A	1A	1A
Peak Current	6A	5A	3.5A	3A	1.5A
Operating Temperature	-55~155°C				

9.PACKAGING

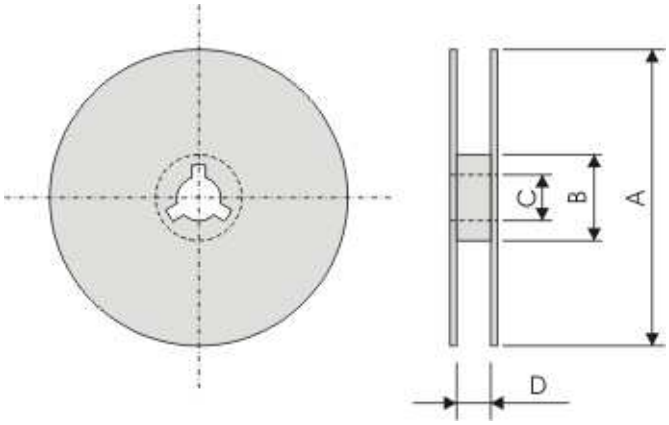
9.1 Paper Tape specifications(unit :mm)



Series No.	A	B	W	F	E
RCR10	3.60±0.20	3.00±0.20	8.00±0.30	3.50±0.20	1.75±0.10
RCR06	3.60±0.20	2.00±0.20			
RCR05	2.40±0.20	1.65±0.20			
RCR03	1.90±0.20	1.10±0.20			
RCR02	1.20±0.10	0.70±0.10			

Series No.	P1	P0	ΦD	T
RCR10	4.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	Max. 1.0
RCR06 / RCR05				
RCR03				0.65±0.05
RCR02	2.00±0.10			0.40±0.05

9.2 7” Reel dimensions



Symbol	A	B	C	D
(unit : mm)	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	9.0±0.5